



## SDM 5572/5579 SR-UG (GaAsP/GaP-GaP)

### Orange SR SIDE (GaAsP/Gap)

Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

Power dissipation/Total	1000	mW
Power dissipation/Chip	30	mW
Forward current	15	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Electrical/Optical Characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V <sub>F</sub>	I <sub>F</sub> = 10mA	—	2.0	2.2	V
Reverse current/Chip	I <sub>R</sub>	V <sub>R</sub> = 4V	—	—	10	μA
Luminous Intensity/Chip	I <sub>v</sub>	I <sub>F</sub> = 10mA	500	1000	—	μcd
Peak wavelength	λ <sub>P</sub>	I <sub>F</sub> = 10mA	—	635	—	nm
Spectral line halfwidth	Δλ	I <sub>F</sub> = 10mA	—	35	—	nm

### Yellow-green UG SIDE (GaP)

Absolute Maximum Ratings (T<sub>a</sub> = 25°C)

Power dissipation/Total	1000	mW
Power dissipation/Chip	30	mW
Forward current	15	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Electrical/Optical Characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V <sub>F</sub>	I <sub>F</sub> = 10mA	—	2.1	2.3	V
Reverse current/Chip	I <sub>R</sub>	V <sub>R</sub> = 4V	—	—	10	μA
Luminous intensity/Chip	I <sub>v</sub>	I <sub>F</sub> = 10mA	600	1200	—	μcd
Peak wavelength	λ <sub>P</sub>	I <sub>F</sub> = 10mA	—	565	—	nm
Spectral line halfwidth	Δλ	I <sub>F</sub> = 10mA	—	30	—	nm

\* Pulse Width . . . . . 1 ms  
Duty Cycle . . . . . 1/5